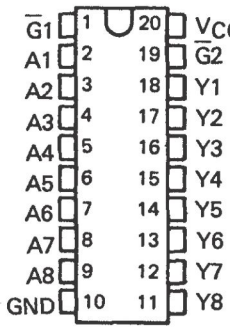
SN54LS540, SN54LS541, SN74LS540, SN74LS541
OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

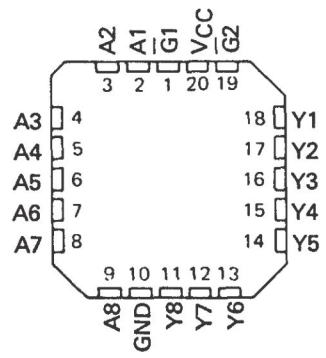
SDLS180 – AUGUST 1979 – REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- P-N-P Inputs Reduce D-C Loading
- Hysteresis at Inputs Improves Noise Margins
- Data Flow-thru Pinout (All Inputs on Opposite Side from Outputs)

SN54LS540, SN54LS541 . . . J OR W PACKAGE
SN74LS540, SN74LS541 . . . DW OR N PACKAGE
(TOP VIEW)



SN54LS540, SN54LS541 . . . FK PACKAGE
(TOP VIEW)



description

These octal buffers and line drivers are designed to have the performance of the popular SN54LS240/SN74LS240 series and, at the same time, offer a pinout having the inputs and outputs on opposite sides of the package. This arrangement greatly enhances printed circuit board layout.

The three-state control gate is a 2-input NOR such that if either $\overline{G1}$ or $\overline{G2}$ are high, all eight outputs are in the high-impedance state.

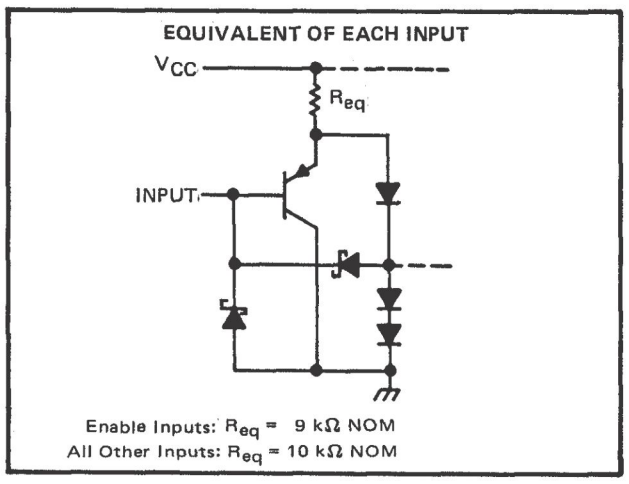
The 'LS540 offers inverting data and the 'LS541 offers true data at the outputs.

The SN54LS540 and SN54LS541 are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LS540 and SN74LS541 are characterized for operation from 0°C to 70°C.

TYPE	RATED I_{OL} (SINK CURRENT)	RATED I_{OH} (SOURCE CURRENT)	TYPICAL POWER DISSIPATION (ENABLED) 'LS540	'LS541
SN54LS'	12 mA	– 12 mA	92.5 mW	120 mW
SN74LS'	24 mA	– 15 mA	92.5 mW	120 mW

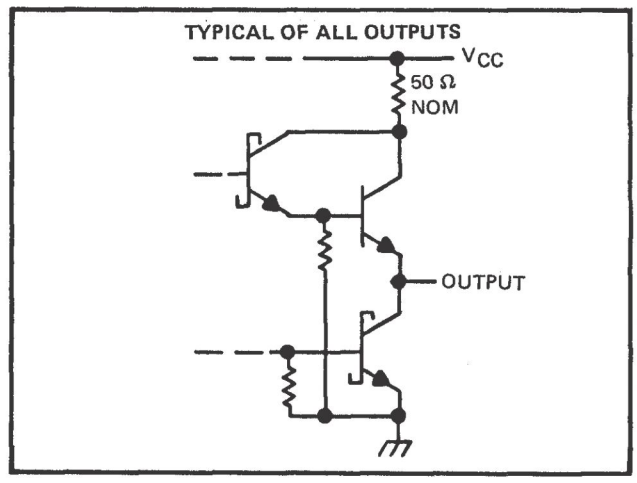
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT

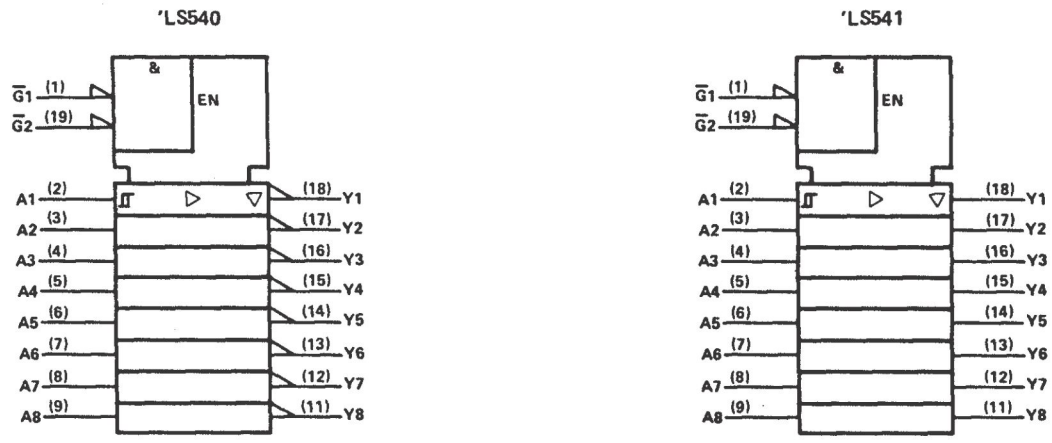


Enable Inputs: R_{eq} = 9 kΩ NOM
All Other Inputs: R_{eq} = 10 kΩ NOM

TYPICAL OF ALL OUTPUTS

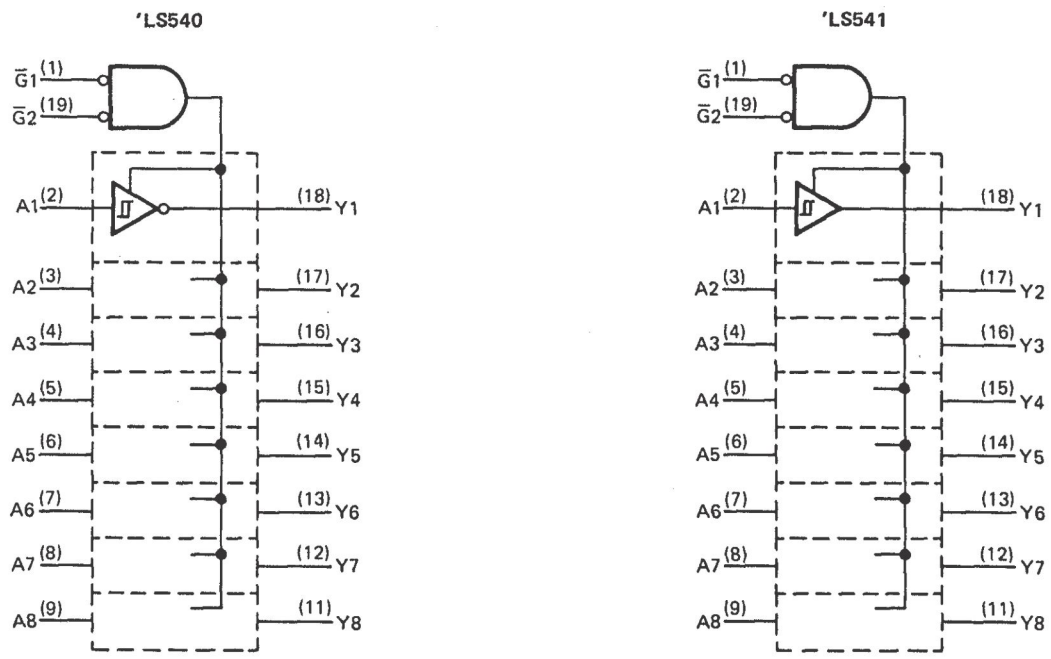


logic symbols†



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Operating free-air temperature range: SN54LS540, SN54LS541 . . . . . −55°C to 125°C
SN74LS540, SN74LS541 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

PARAMETER	SN54LS'			SN74LS'			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC} (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−12			−15	mA
Low-level output current, I_{OL}			12			24	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

NOTE 1: Voltage values are with respect to network ground terminal.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS'			SN74LS'			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.6			0.6	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
	Hysteresis (V_{T+} − V_{T-})		V_{CC} = MIN		0.2	0.4		0.2	0.4		V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −3 mA	2.4	3.4		2.4	3.4		V
			V_{CC} = MIN, V_{IL} = 0.5 V,	V_{IH} = 2V, I_{OH} = MAX	2			2			
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 24 mA					0.35	0.5	
I_{OZH}	Off-state output current, high-level voltage applied		V_{CC} = MAX, V_{IH} = 2 V, V_{IL} = V_{IL} max	V_O = 2.7 V			20			20	μA
I_{OZL}	Off-state output current, low-level voltage applied			V_O = 0.4 V			−20			−20	
I_I	Input current at maximum input voltage		V_{CC} = MAX,	V_I = 7 V			0.1			0.1	mA
I_{IH}	High-level input current, any input		V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	Low-level input current		V_{CC} = MAX,	V_I = 0.4 V			−0.2			−0.2	mA
I_{OS}	Short-circuit output current§		V_{CC} = MAX		−40		−225	−40		−225	mA
I_{CC}	Supply current	Outputs high	V_{CC} = MAX, Outputs open	'LS540		13	25		13	25	mA
				'LS541		18	32		18	32	
		Outputs low		'LS540		24	45		24	45	
				'LS541		30	52		30	52	
		All outputs disabled		'LS540		30	52		30	52	
				'LS541		32	55		32	55	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	'LS540			'LS541			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 45 pF, R_L = 667 Ω, See Note 2		9	15		9	15	ns
t_{PHL}	Propagation delay time, high-to-low-level output			9	15		10	18	ns
t_{PZL}	Output enable time to low level			25	38		25	38	ns
t_{PZH}	Output enable time to high level			15	25		20	32	ns
t_{PLZ}	Output disable time from low level	C_L = 5 pF, R_L = 667 Ω, See Note 2		10	18		10	18	ns
t_{PHZ}	Output disable time from high level			15	25		18	29	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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